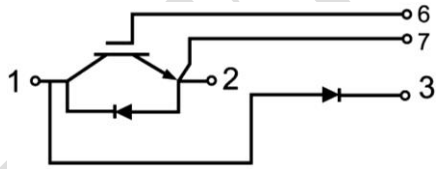
GT150CU120T1VH
GT150CL120T1VH
IGBT Module

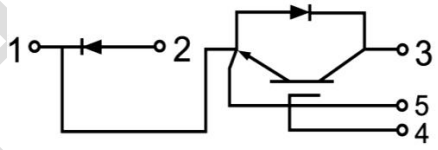
Features：

- Field Stop Trench Gate IGBT
- Short Circuit Rated>10μs
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested(2×Ic)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement

Circuit Diagram



CU



CL

Applications：

- Welding
- HEV Inverter
- Industrial Motor Drives
- UPS

IGBT, Brake-Chopper
Maximum Rated Values of IGBT

V_{CES}	Collector-Emitter Blocking Voltage	T_J=25℃	1200	V
V_{GES}	Gate-Emitter Voltage		±20	V
I_C	Continuous Collector Current	T_C=100℃	150	A
		T_C=25℃	280	A
I_{CM}	Repetitive Peak Collector Current	tp=1ms	300	A
t_{SC}	Short Circuit Withstand Time		>10	μs
P_D	Maximum Power Dissipation per IGBT	T_C=25℃ T_{Jmax}=175℃	950	W

Electrical Characteristics of IGBT

Static Characteristics

Symbol	Description	Conditions		Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C=4mA, V_{CE}=V_{GE}, T_J=25℃		5.0	5.8	6.6	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I_C=75A, V_{GE} =15V	T_J=25℃		1.90	2.10	V
			T_J=125℃		2.10		V
I_{CES}	Collector-Emitter Leakage Current	V_{GE}= 0V, V_{CE}=V_{CES}, T_J=25℃				1	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE} = ±20V, V_{CE}=0V, T_J=25℃				200	nA
C_{ies}	Input Capacitance	V_{CE}=25V, V_{GE}=0V, f=100kHz, T_J=25℃			13.51		nF
C_{oes}	Output Capacitance				0.83		nF
C_{res}	Reverse Transfer Capacitance				0.18		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	V_{CC}= 600V,I_C=150A, R_{Gon}=2Ω,V_{GE}= ±15V, Inductive Load	T_J=25℃		270		ns
			T_J=125℃		285		
t_r	Rise Time		T_J=25℃		78.0		ns
			T_J=125℃		85.0		
$t_{d(off)}$	Turn-off Delay Time	V_{CC}=600V,I_C=150A, R_{Goff} =2Ω,V_{GE}= ±15V, Inductive Load	T_J=25℃		208		ns
			T_J=125℃		216		
t_f	Fall Time		T_J=25℃		147		ns
			T_J=125℃		201		
E_{on}	Turn-on Switching Loss	V_{CC}=600V,I_C=150A, R_{Gon} =2Ω,V_{GE}= ±15V, di/dt=1510A/μs(T_J=125℃), Inductive Load	T_J=25℃		6.3		mJ
			T_J=125℃		7.5		
E_{off}	Turn-off Switching Loss	V_{CC}=600V,I_C=150A, R_{Goff} =2Ω,V_{GE}=±15V, du/dt=7328A/μs(T_J=125℃), Inductive Load	T_J=25℃		6.8		mJ
			T_J=125℃		10.2		
Q_g	Total Gate Charge	V_{GE}=+15V…-15V	T_J=25℃		685		nC
R_{gint}	Internal Gate Resistor		T_J=25℃		5.0		Ω
RBSOA	I_C=300A,V_{CC}=1050V,Vp=1200V, R_{Goff} = 2Ω, V_{GE}=+15V to 0V, T_J =150°C			Trapezoid			
SCSOA	V_{CC}=600V, V_{GE}=15V, T_J=125℃			10			μs
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case					0.157	℃/W

Diode, Reverse
Maximum Rated Values of Diode

V_{RRM}	Repetitive Peak Reverse Voltage	T_J=25℃	1200	V
I_F	Diode Continuous Forward Current		100	A
I_{FM}	Peak FWD Current Repetitive	tp=1ms	200	A

Electrical Characteristics of Diode

Symbol	Description	Conditions		Min	Typ	Max	Unit
V_{FM}	Forward Voltage	I_F=100A	T_J=25℃		2.10		V
			T_J=125℃		2.30		
t_{rr}	Reverse Recovery Time	I_F=100A, -diF/dt =1345A/μs(T_J=125℃), V_R=600V, V_{GE}=-15V	T_J=25℃		253		ns
			T_J=125℃		374		
I_{rr}	Peak Reverse Recovery Current		T_J=25℃		70		A
			T_J=125℃		78		
Q_{rr}	Reverse Recovery Charge		T_J=25℃		7.95		μC
			T_J=125℃		11.99		
E_{rec}	Reverse Recovery Energy		T_J=25℃		3.4		mJ
			T_J=125℃		5.0		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case					0.411	℃/W

Diode, Brake--Chopper
Maximum Rated Values of Diode

V_{RRM}	Repetitive Peak Reverse Voltage	T_J=25℃	1200	V
I_F	Diode Continuous Forward Current		150	A
I_{FM}	Diode Maximum Forward Current	tp=1ms	300	A

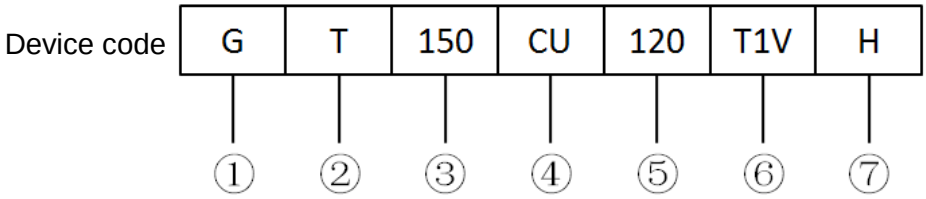
Electrical Characteristics of Diode

Symbol	Description	Conditions		Min	Typ	Max	Unit
V_{FM}	Forward Voltage	I_F=150A	T_J=25℃		2.20		V
			T_J=125℃		2.40		
t_{rr}	Reverse Recovery Time	I_F=150A, -di$_F$/dt =1910A/μs(T_J=125℃), V_R=600V, V_{GE}=-15V	T_J=25℃		156		ns
			T_J=125℃		393		
I_{rr}	Peak Reverse Recovery Current		T_J=25℃		91.0		A
			T_J=125℃		111		
Q_{rr}	Reverse Recovery Charge		T_J=25℃		8.40		μC
			T_J=125℃		17.1		
E_{rec}	Reverse Recovery Energy		T_J=25℃		4.5		mJ
			T_J=125℃		8.3		
$R_{\theta JC}$	Diode Thermal Resistance: Junction-To-Case					0.345	℃/W

Module

Symbol	Description		Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500			V
T_J	Maximum Junction Temperature				175	℃
T_{JOP}	Maximum Operating Junction Temperature Range		-40		+150	℃
T_{stg}	Storage Temperature		-40		+125	℃
CTI	Comparative Tracking Index		200			
$R_{\theta CS}$	Case-to-Sink Thermally (Conductive Grease Applied)				0.07	℃/W
T	Power Terminals Screw:M5		3.0		5.0	N·m
T	Mounting Screw:M6		4.0		6.0	N·m
G	Weight			165		g

Ordering Information Table



① - IGBT Module
② - Field Stop Trench Gate IGBT
③ - Rated Current (150=150A)
④ - Circuit Configuration: Chopper, CU(Diode on High Side) / CL(Diode on Low Side)
⑤ - Rated Voltage (120=1200V)
⑥ - Package Type
⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

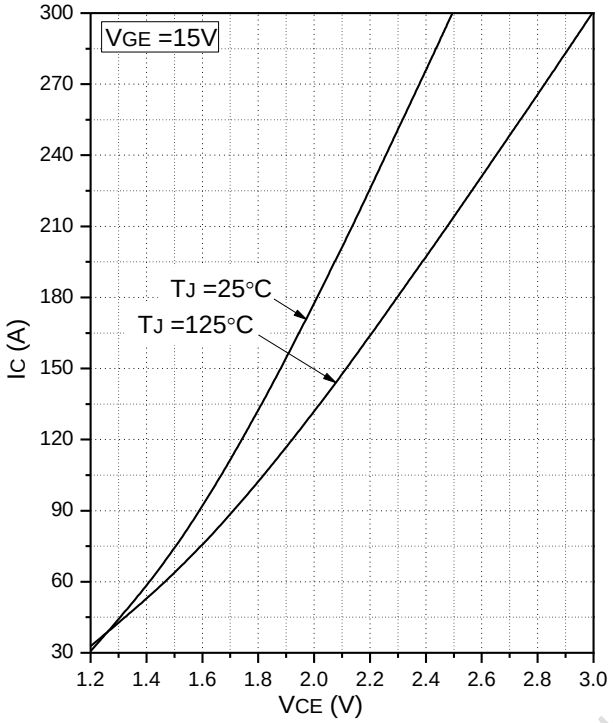


Fig.1 Typical Saturation Voltage Characteristics

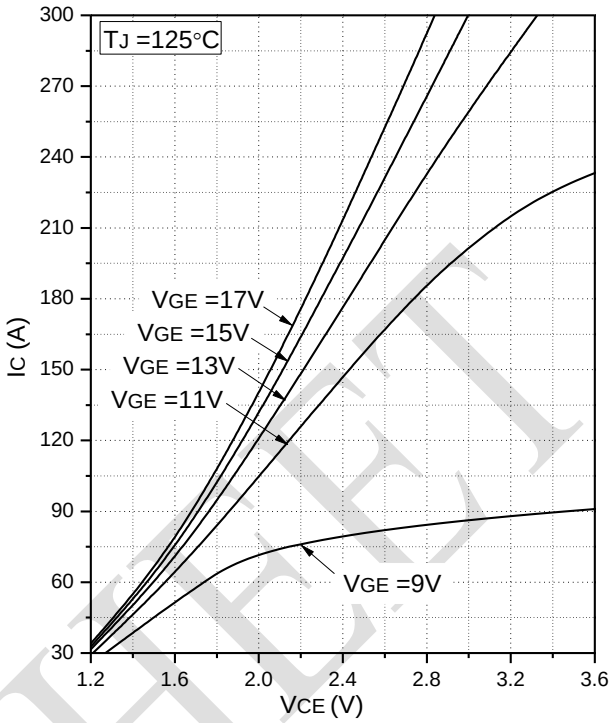


Fig.2 Typical Output Characteristics

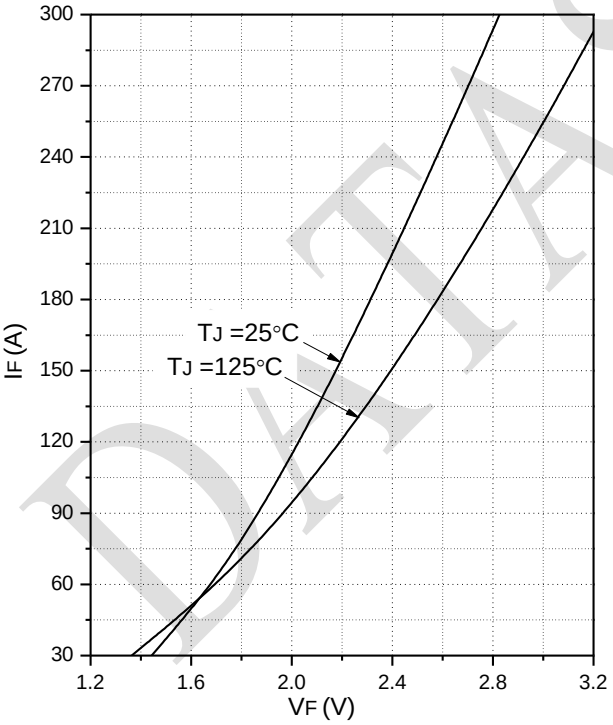


Fig.3 Forward Characteristics of Diode-Chopper

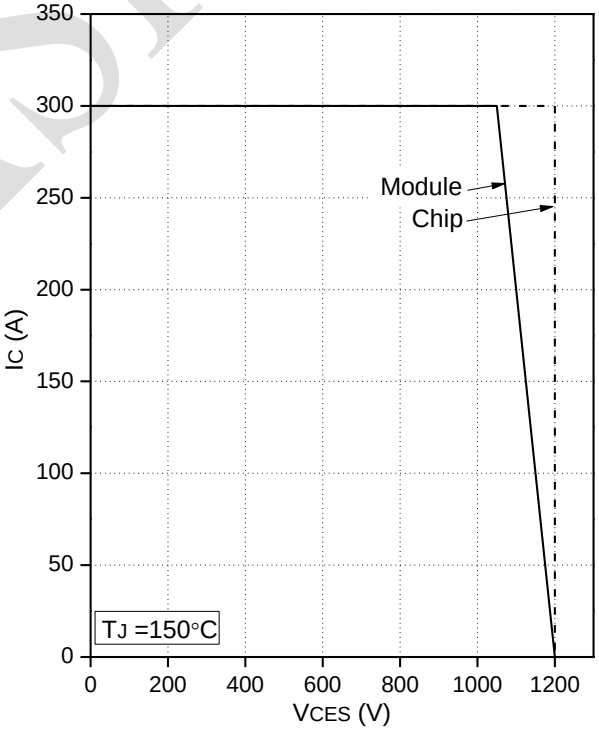


Fig.4 Reverse Bias Safe Operation Area (RBSOA)

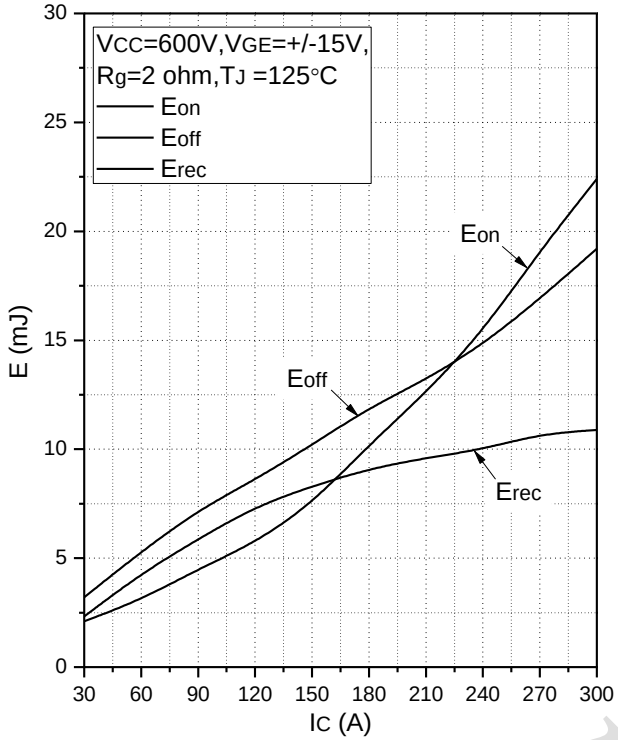


Fig.5 Typical Switching Loss vs. Collector Current

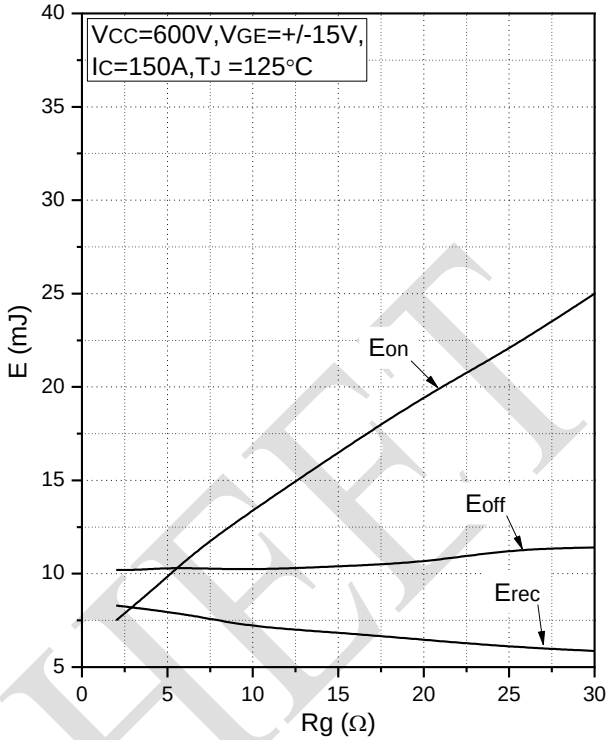


Fig.6 Typical Switching Loss vs. Gate Resistance

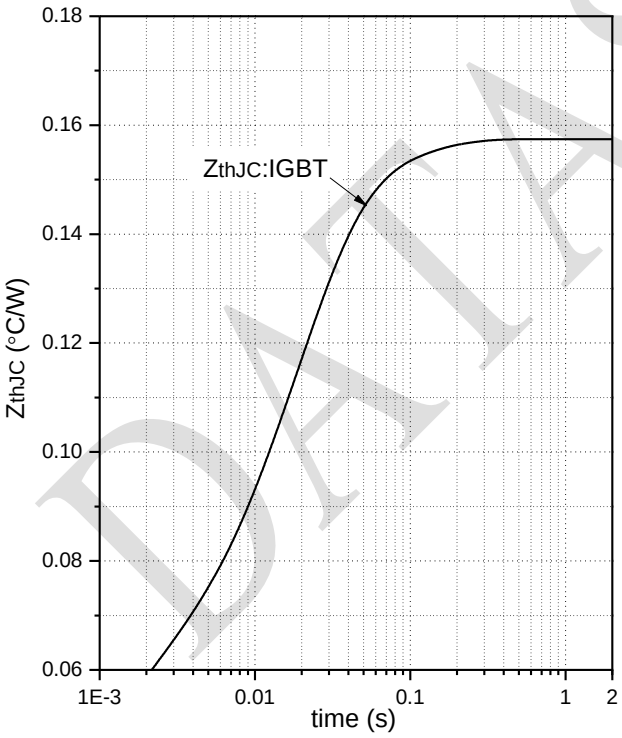


Fig.7 Transient Thermal Impedance (IGBT)

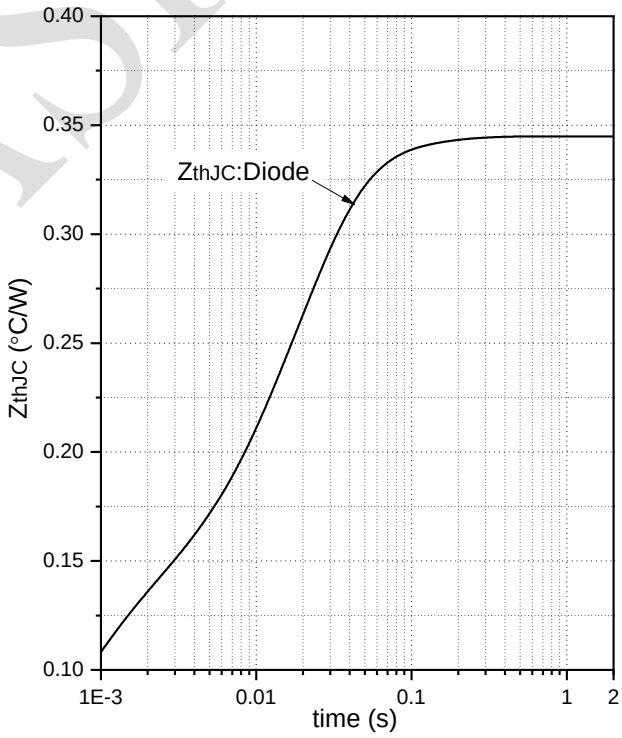


Fig.8 Transient Thermal Impedance (Diode-Chopper)

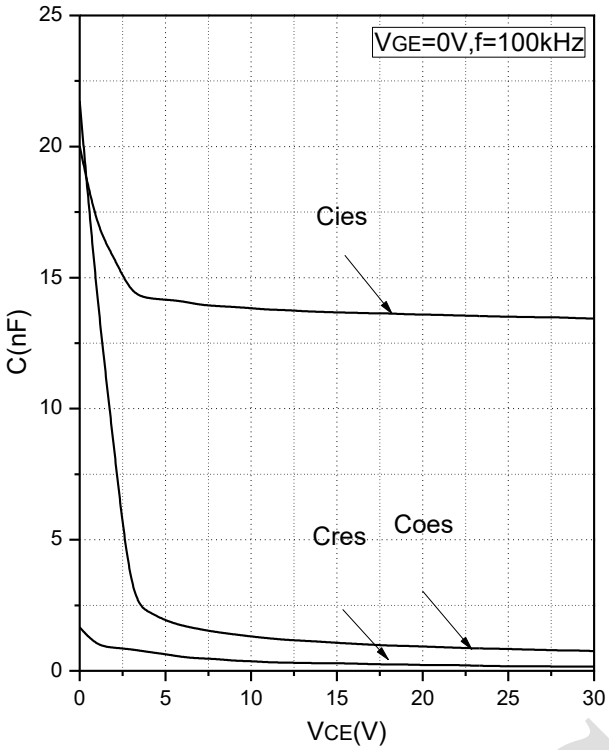


Fig.9 Capacitance Characteristics

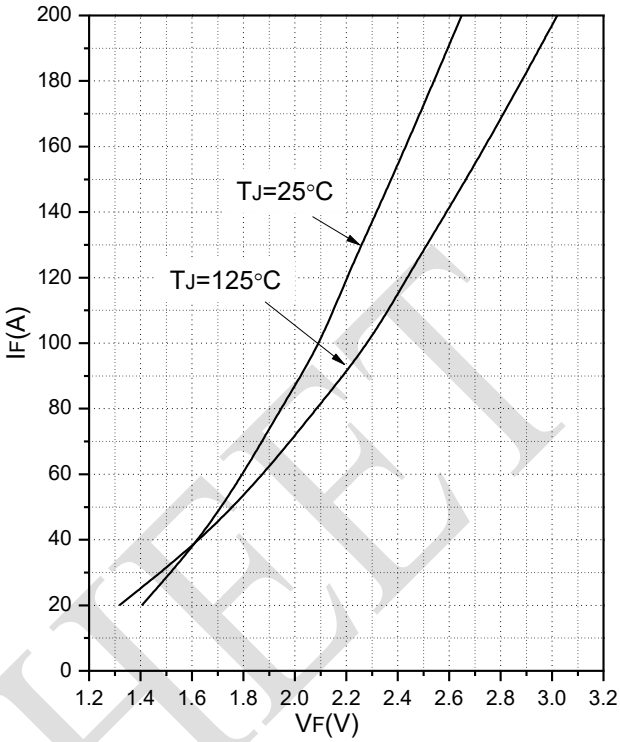
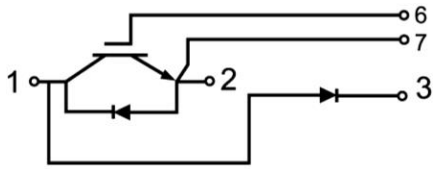
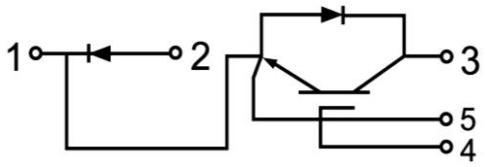


Fig.10 Forward Characteristics of Reverse Diode

Internal Circuit

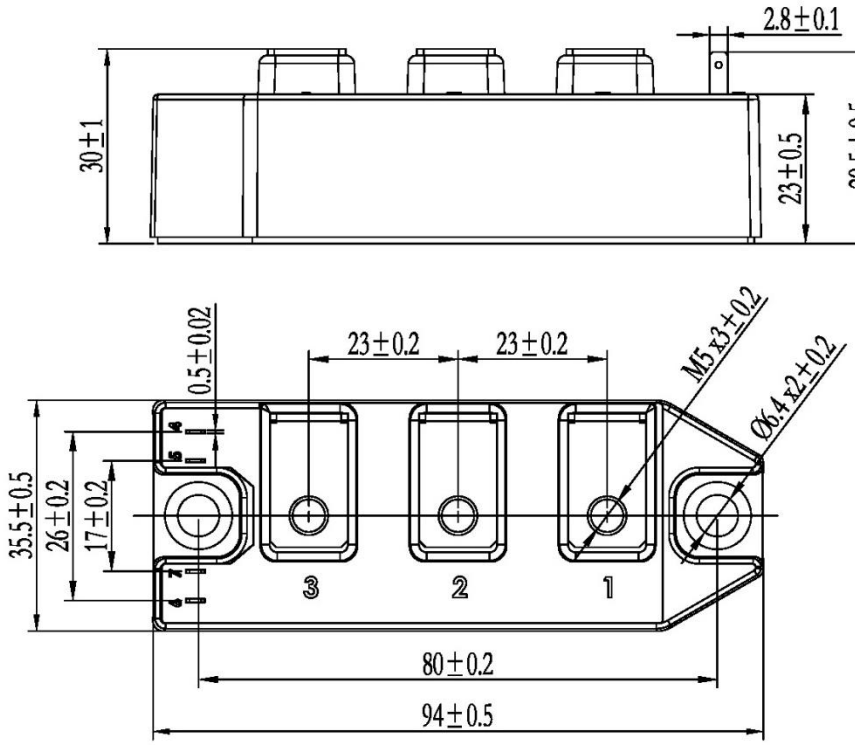


CU



CL

Package Outline (Unit: mm):



Date	Revision	Notes
06/17/2022	A	Final Version

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